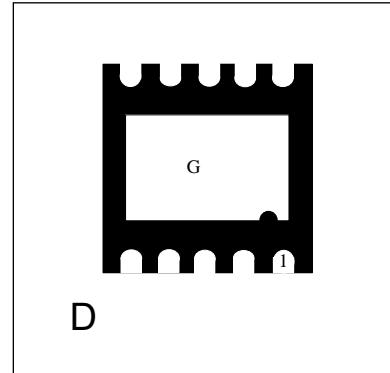




Features

- Array of surge rated diodes with internal TVS Diode
- Small package saves board space
- Protects up to four I/O lines
- Low capacitance for high-speed interfaces
- Low leakage current and clamping voltage
- Low operating voltage: 3.3V
- Solid-state silicon-avalanche technology



IEC Compatibility (EN61000-4)

- IEC 61000-4-2 (ESD) $\pm 30\text{kV}$ (air), $\pm 30\text{kV}$ (contact)
- IEC 61000-4-4 (EFT) 40A (5/50ns)
- IEC 61000-4-5 (Lightning) 28A (8/20 μs)

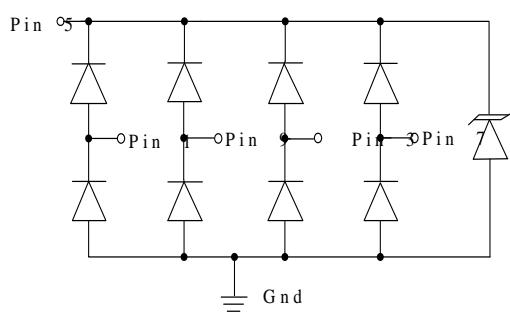
Mechanical Characteristics

- DFN2.6x2.6-10L package ($2.6 \times 2.6 \times 0.5\text{mm}$)
- Molding compound flammability rating: UL 94V-0
- Marking: Marking Code+ Data Code
- Packaging: Tape and Reel
- RoHS Compliant

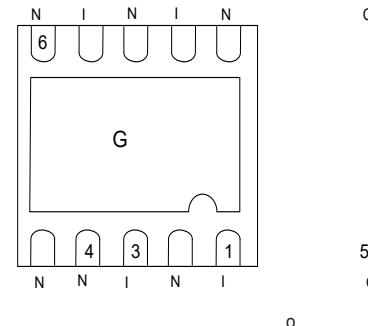
Applications

- USB 2.0
- 10/100/1000 Ethernet
- Digital Visual Interface (DVI)
- T1/E1 Secondary Protection
- T3/E3 Secondary Protection
- Analog Video

Circuit Diagram



Package Configuration



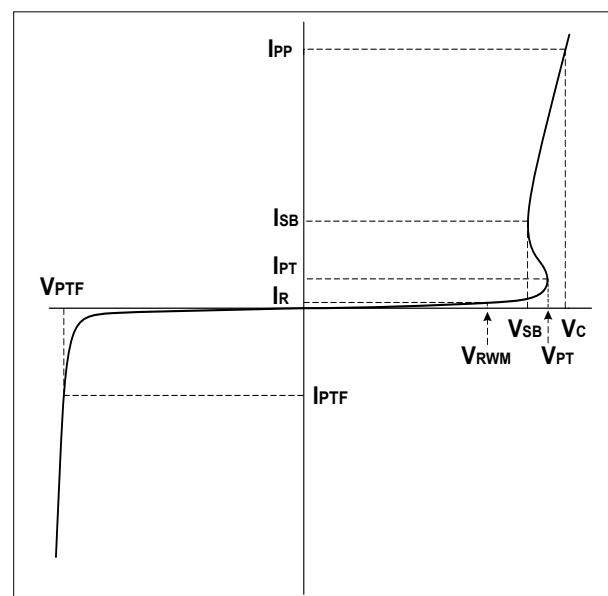


Absolute Maximum Rating

Rating	Symbol	Value	Units
Peak Pulse Power ($t_p = 8/20\mu s$)	P_{PP}	500	Watts
Operating Temperature	T_J	-55 to +125	°C
Storage Temperature	T_{STG}	-55 to +150	°C

Electrical Parameters (T=25°C)

Symbol	Parameter
I_{PP}	Reverse Peak Pulse Current
V_C	Clamping Voltage @ I_{PP}
V_{RWM}	Reverse Stand-Off Voltage
I_R	Reverse Leakage Current @ V_{RWM}
V_{PT}	Punch-through Breakdown Voltage @ I_T
V_{SB}	Snap-Back Voltage @ I_{SB}
I_{SB}	Snap-Back Current
I_{PT}	Test Current
V_{PTF}	Forward Punch-through Breakdown Voltage @ I_{PTF}
I_{PTF}	Forward Test Current



Electrical Characteristics

Parameter	Symbol	Conditions	Minimum	Typical	Maximum	Units
Reverse Stand-Off Voltage	V_{RWM}	Any I/O pin to ground			3.3	V
Reverse Breakdown Voltage	V_{BR}	$I_t = 1mA$ Any I/O pin to ground	3.5			V
Snap-Back Voltage	V_{SB}	$I_{SB} = 50mA$ Any I/O pin to ground	2.8			
Reverse Leakage Current	I_R	$V_{RWM} = 3.3V, T=25^\circ C$ Any I/O pin to ground			500	nA
Clamping Voltage	V_C	$I_{PP}=28A, t_p=8/20\mu s$ Any I/O pin to ground		14	18	V
ESD Clamping Voltage ¹	V_C	$I_{PP} = 4A$ $t_p = 0.2/100ns$		8.4		V
ESD Clamping Voltage ¹	V_C	$I_{PP} = 16A$ $t_p = 0.2/100ns$		11.2		V
Dynamic Resistance ^{1,2}	R_{DYN}	$TLP=0.2/100ns$		0.22		Ω
Junction Capacitance	C_j	$V_R = 0V, f = 1MHz$ I/O pin to GND		2.7	4	pF
		$V_R = 0V, f = 1MHz$ Between I/O pins		1.3	3	pF

Note: 1、TLP Setting : $t_p=100ns$, $t_f=0.2ns$, I_{TLP} and V_{TLP} sample window: $t_1=70ns$ to $t_2=90ns$.

2、Dynamic resistance calculated from $I_{PP}=4A$ to $I_{PP}=16A$ using “Best Fit”



Typical Characteristics

Figure 1: Peak Pulse Power vs. Pulse Time

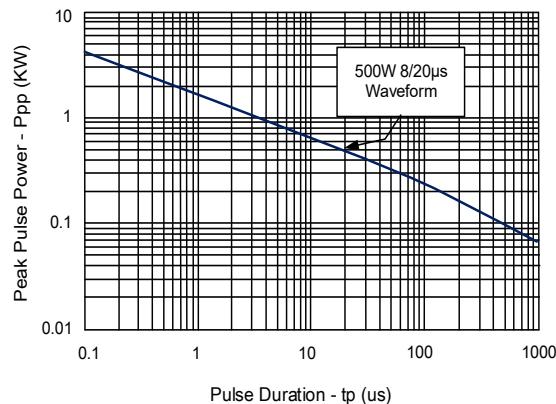


Figure 2: Power Derating Curve

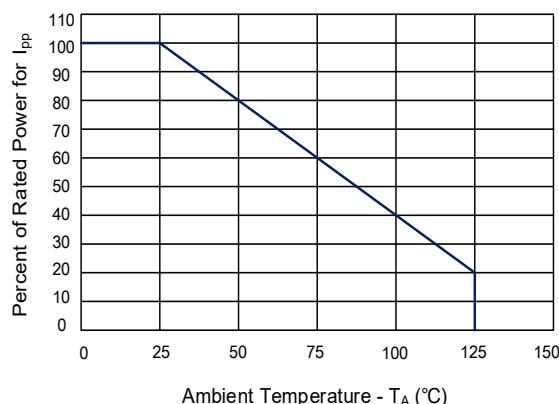


Figure 3: Clamping Voltage vs. Peak Pulse Current

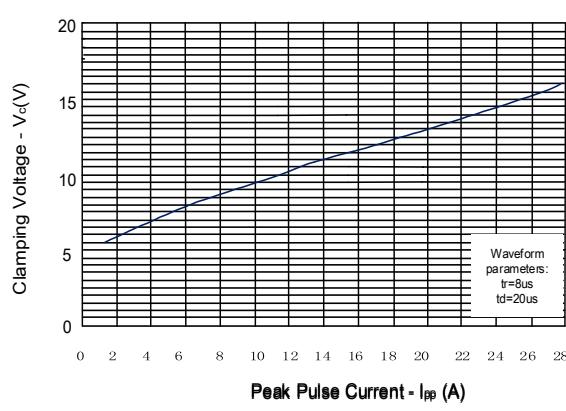


Figure 4: Capacitance vs. Reverse Voltage

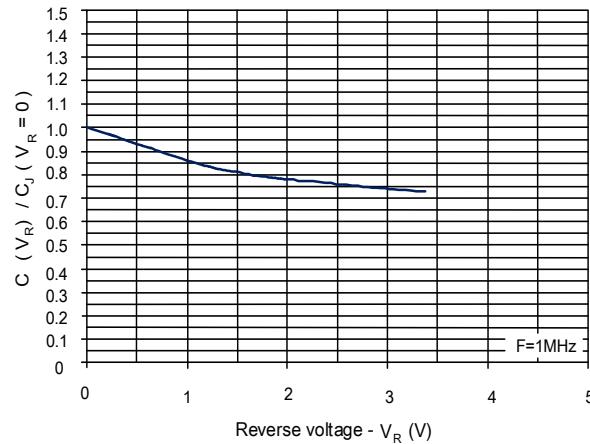


Figure 5: 8/20μs Pulse Waveform

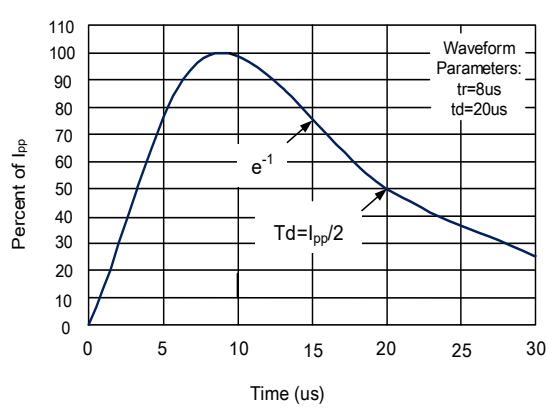
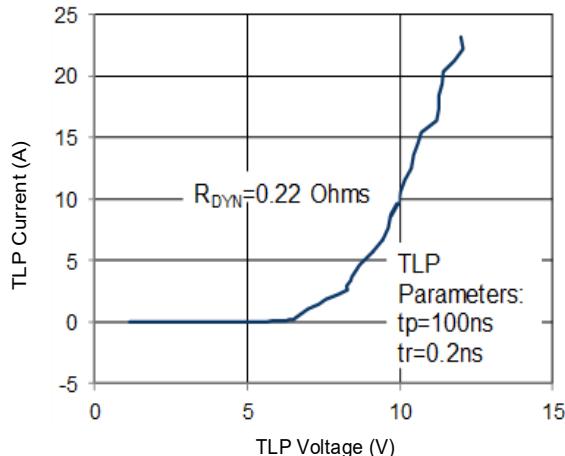


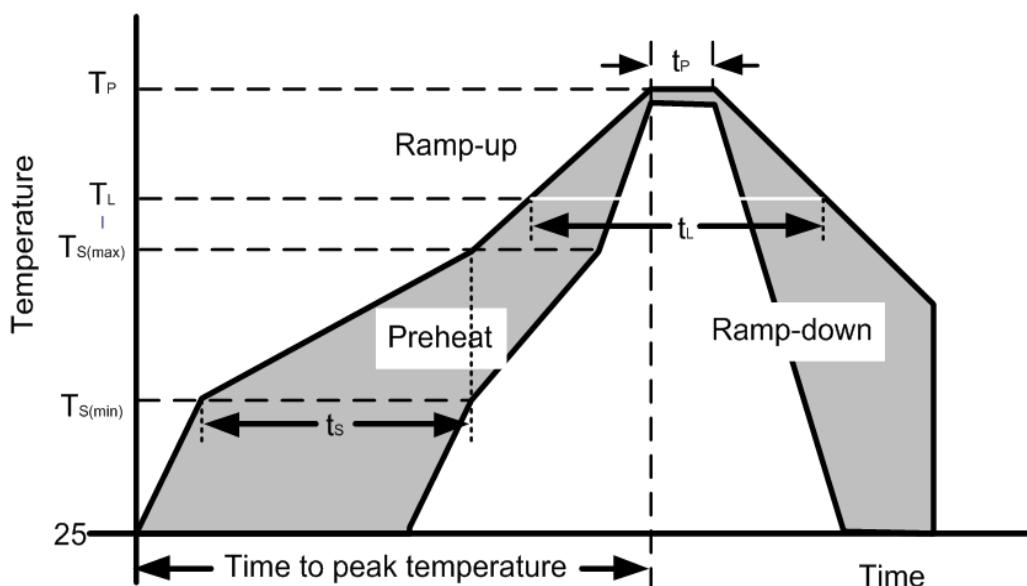
Figure 6: TLP I-V Curve





Soldering Parameters

Reflow Condition		Pb – Free assembly
Pre Heat	Temperature Min ($T_{s(min)}$)	150°C
	Temperature Max ($T_{s(max)}$)	200°C
	Time (min to max) (t_s)	60 – 190 secs
Average ramp up rate (Liquidus Temp) (T_L) to peak		5°C/second max
$T_{s(max)}$ to T_L —Ramp-up Rate		5°C/second max
Reflow	Temperature (T_L) (Liquidus)	217°C
	Temperature (t_L)	60 – 150 seconds
	Peak Temperature (T_P)	260+0/-5 °C
Time within actual peak Temperature (t_p)		20 – 40 seconds
Ramp-down Rate		5°C/second max
Time 25°C to peak Temperature (T_P)		8 minutes Max.
Do not exceed		280°C

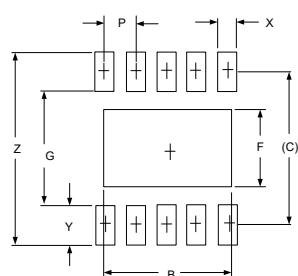




Outline Drawing –DFN2.6x2.6-10L

<p>NOTES: 1. Controlling dimensions are in millimeters (angles in degrees). 2. Coplanarity applies to the exposed pad as well as the terminals.</p>	<p>DFN2.6x2.6-10L</p> <table border="1"><thead><tr><th colspan="4">DEMENSIONS</th></tr><tr><th rowspan="2">SYMBOL</th><th colspan="2">MILLIMETERS</th><th colspan="2">INCHES</th></tr><tr><th>MIN.</th><th>MAX.</th><th>MIN.</th><th>MAX.</th></tr></thead><tbody><tr><td>A</td><td>0.450</td><td>0.550</td><td>0.018</td><td>0.022</td></tr><tr><td>A2</td><td>0.000</td><td>0.050</td><td>0.000</td><td>0.002</td></tr><tr><td>A1</td><td colspan="2">0.150</td><td colspan="2">0.006</td></tr><tr><td>D</td><td>2.550</td><td>2.650</td><td>0.101</td><td>0.105</td></tr><tr><td>D1</td><td>2.100</td><td>2.200</td><td>0.083</td><td>0.087</td></tr><tr><td>E</td><td>2.550</td><td>2.650</td><td>0.101</td><td>0.105</td></tr><tr><td>E1</td><td>1.210</td><td>1.310</td><td>0.048</td><td>0.052</td></tr><tr><td>b</td><td>0.200</td><td>0.300</td><td>0.008</td><td>0.012</td></tr><tr><td>e</td><td colspan="2">0.500BSC.</td><td colspan="2">0.020BSC</td></tr><tr><td>L</td><td>0.300</td><td>0.400</td><td>0.012</td><td>0.016</td></tr></tbody></table>	DEMENSIONS				SYMBOL	MILLIMETERS		INCHES		MIN.	MAX.	MIN.	MAX.	A	0.450	0.550	0.018	0.022	A2	0.000	0.050	0.000	0.002	A1	0.150		0.006		D	2.550	2.650	0.101	0.105	D1	2.100	2.200	0.083	0.087	E	2.550	2.650	0.101	0.105	E1	1.210	1.310	0.048	0.052	b	0.200	0.300	0.008	0.012	e	0.500BSC.		0.020BSC		L	0.300	0.400	0.012	0.016
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Land Pattern



DIMENSIONS		
DIM	INCHE S	MILLIMETE RS
B	.081	2.05
C	.100	2.50
F	.050	1.26
G	.073	1.85
P	.020	0.50
X	.012	0.30
Y	.025	0.65
Z	.124	3.15

NOTES:

1. This land pattern is for reference purposes only. Consult your manufacturing to ensure your company's manufacturing guidelines are met.

Marking Codes

Part Number	DW3.3-4R1N-S	Marking Code	2201 YYWW (YYWW: Date Code)
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Package Information

Qty: 3k/Reel